

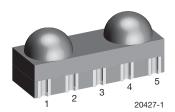


RoHS

HALOGEN

FREE

# **IR Receiver Modules for Remote Control Systems**



#### **MECHANICAL DATA**

#### **Pinning**

1, 4, 5 = GND,  $2 = V_S$ , 3 = OUT

#### **FEATURES**

- Very low supply current
- Photo detectors and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- Capable of side or top view
- Two lenses for high sensitivity and wide receiving angle
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **DESCRIPTION**

These products are miniaturized receivers for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy package acts as an IR filter.

The demodulated output signal can be directly connected to a microprocessor. The TSOP852.. are legacy products for all common IR remote control data formats.

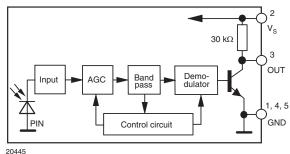
The TSOP854.. is optimized to suppress almost all spurious pulses from energy saving fluorescent lamps. They may suppress some data signals.

This component has not been qualified according to automotive specifications.

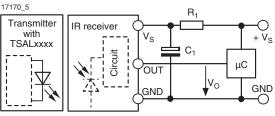
PARTS T	ABLE			
AGC		LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2)	RECOMMENDED FOR LONG BURST CODES (AGC4) <sup>(1)</sup>	
	30 kHz	TSOP85230	TSOP85430	
Carrier frequency	33 kHz	TSOP85233	TSOP85433	
	36 kHz	TSOP85236	TSOP85436 (2)(3)(4)	
	38 kHz	TSOP85238	TSOP85438 (5)(6)(9)	
	40 kHz	TSOP85240	TSOP85440	
	56 kHz	TSOP85256	TSOP85456 (7)(8)	
Daalaaaa	Pinning	1, 4, 5 = GND, 2 = V <sub>S</sub> , 3 = OUT		
Package Dimensions (mm) 8.0 H >		8.0 H x 3.3	3.3 W x 2.7 L	
Mounting		SN	MD	
Application		Remote control		
Best remote	e control code	(2) RC-5 (3) RC-6 (4) Panasonic (5) NEC (6) S	Sharp <sup>(7)</sup> r-step <sup>(8)</sup> Thomson RCA <sup>(9)</sup> r-map	

#### Note

## **BLOCK DIAGRAM**



## **APPLICATION CIRCUIT**



 $\rm R_1$  and  $\rm C_1$  are recommended for protection against EOS. Components should be in the range of 33  $\Omega$  <  $\rm R_1$  < 1 k $\Omega$ , C, > 0.1  $\mu F$ .

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<sup>(1)</sup> We advise try AGC4 first if the burst length is unknown



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ABSOLUTE MAXIMUM RA	OLUTE MAXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6	V
Supply current		I <sub>S</sub>	3	mA
Output voltage		Vo	-0.3 to (V <sub>S</sub> + 0.3)	V
Output current		Io	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T <sub>stg</sub>	-25 to +85	°C
Operating temperature range		T <sub>amb</sub>	-25 to +85	°C
Power consumption	T <sub>amb</sub> ≤ 85 °C	P <sub>tot</sub>	10	mW
Soldering temperature		T <sub>sd</sub>	260	°C

#### Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

<b>ELECTRICAL AND OPTI</b>	CAL CHARACTERISTICS	$(T_{amb} = 25)^{\circ}$	°C, unless o	otherwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5		5.5	V
Cupply gurrant	$V_S = 3.3 \text{ V}, E_V = 0$	I <sub>SD</sub>	0.27	0.35	0.45	mA
Supply current	E <sub>v</sub> = 40 klx, sunlight	I <sub>SH</sub>		0.45		mA
Transmission distance	$E_{v} = 0$ IR diode TSAL6200, $I_{F} = 250 \text{ mA}$ test signal see fig. 1	d		45		m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see fig. 1	V <sub>OSL</sub>			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi}$ - 5/ $f_o$ < $t_{po}$ < $t_{pi}$ + 6/ $f_o$ test signal see fig. 1	E <sub>e min.</sub>		0.1	0.25	mW/m²
Maximum irradiance	$t_{pi}$ - 5/f <sub>o</sub> < $t_{po}$ < $t_{pi}$ + 6/f <sub>o</sub> , test signal see fig. 1	E <sub>e max.</sub>	30			W/m <sup>2</sup>
Directivity	Angle of half transmission distance	Ψ1/2		± 50		deg

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

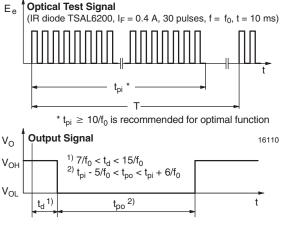


Fig. 1 - Output Active Low

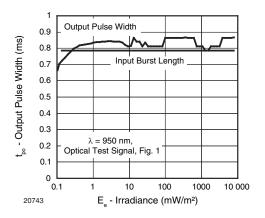


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient





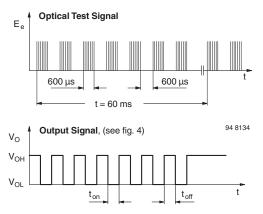


Fig. 3 - Output Function

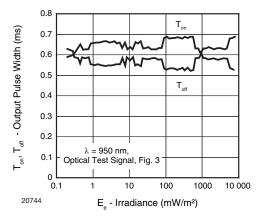


Fig. 4 - Output Pulse Diagram

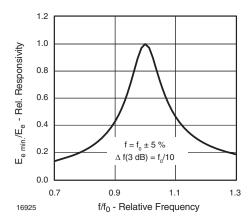


Fig. 5 - Frequency Dependance of Responsivity

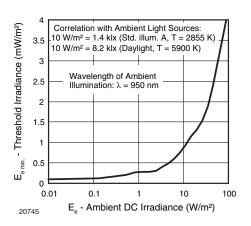


Fig. 6 - Sensitivity in Bright Ambient

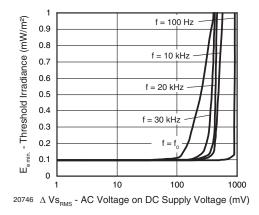


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

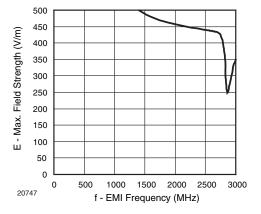


Fig. 8 - Sensitivity vs. Electric Field Disturbances





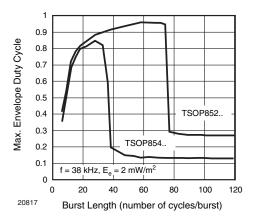


Fig. 9 - Max. Envelope Duty Cycle vs. Burst Length

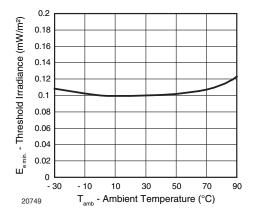


Fig. 10 - Sensitivity vs. Ambient Temperature

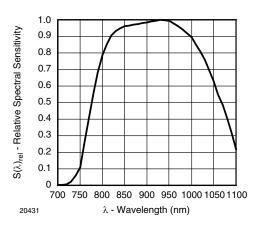


Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

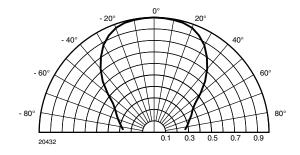


Fig. 12 - Directivity



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## **SUITABLE DATA FORMAT**

The TSOP852.., TSOP854 series are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP852.., TSOP854 in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated noise from fluorescent lamps with electronic ballasts (see fig. 13 or fig. 14)

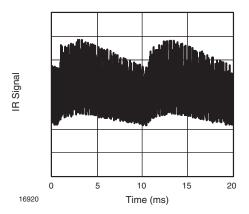


Fig. 13 - IR Signal from Fluorescent Lamp with Low Modulation

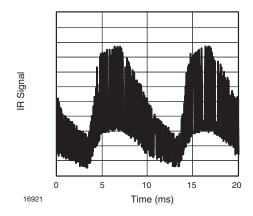


Fig. 14 - IR Signal from Fluorescent Lamp with High Modulation

	TSOP852	TSOP854
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 70 cycles ≥ 10 cycles	10 to 35 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 4 x burst length	35 cycles > 10 x burst length
Maximum number of continuous short bursts/second	1800	1500
Recommended for NEC code	yes	yes
Recommended for RC5/RC6 code	yes	yes
Recommended for Thomson 56 kHz code	yes	yes
Recommended for Mitsubishi code (38 kHz, preburst 8 ms, 16 bit)	yes	no
Recommended for Sharp code	yes	yes
Suppression of interference from fluorescent lamps	Most common disturbance signals are suppressed	Even extreme disturbance signals are suppressed

## Notes

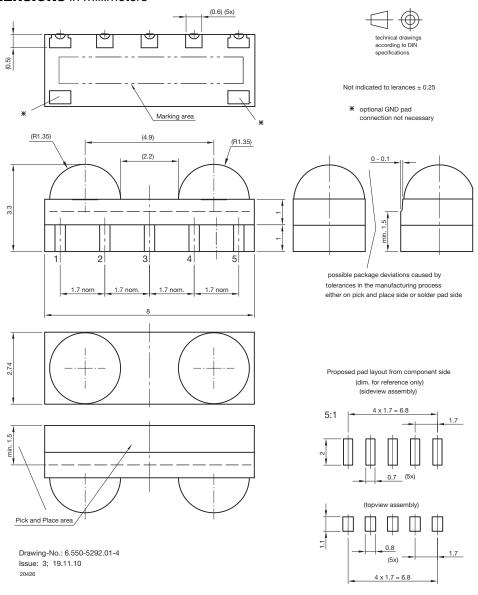
- For data formats with short bursts please see the datasheet for TSOP853.., TSOP855...
- Example of compatible products for IR-codes:
  - -TSOP85436: RC-5, RC-6, Panasonic
  - -TSOP85438: NEC, Sharp, r-map
  - -TSOP85456: r-step, Thomson RCA

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## **PACKAGE DIMENSIONS** in millimeters



## **ASSEMBLY INSTRUCTIONS**

## **Reflow Soldering**

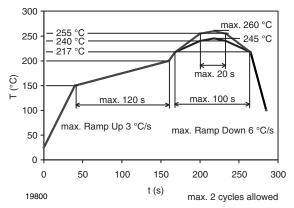
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

## **Manual Soldering**

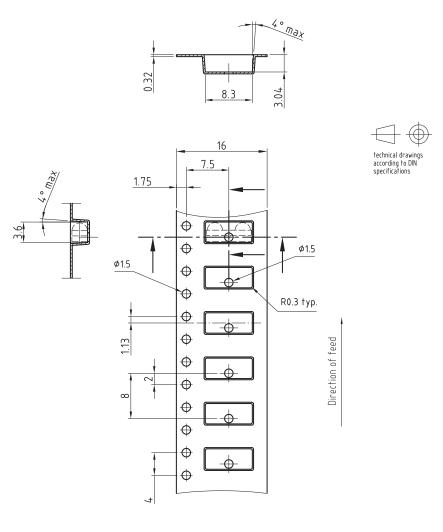
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



## **VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE**



## **TAPING VERSION TSOP..TR DIMENSIONS** in millimeters



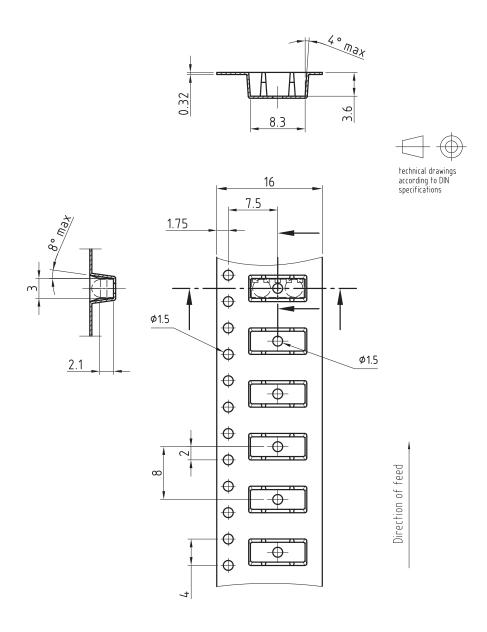
Drawing-No.: 9.700-5316.01-4

Issue: 1; 12.02.07

20628



## TAPING VERSION TSOP..TT DIMENSIONS in millimeters



Drawing-No.: 9.700-5317.01-4

Issue: 2; 10.04.08

20629



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## **LABEL**

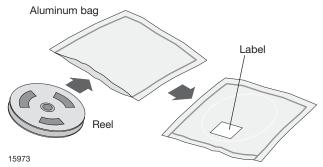
#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

#### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



## www.vishay.com

# TSOP852.., TSOP854..

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# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

## **BAR CODE PRODUCT LABEL** (example)



22170

# CAUTION This bag contains MOISTURE-SENSITIVE DEVICES 1. Shelf life in sealed bag: 12 months at < 40 °C and < 90 % relative humidity (RH) 2. After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 °C) must be 2a. Mounted within 72 hours at factory condition of < 30 °C/60 % RH or 2b. Stored at < 5 % RH 3. Devices require baking befor mounting if: Humidity Indicator Card is > 10 % when read at 23 °C ± 5 °C or 2a. or 2b. are not met. 4. If baking is required, devices may be baked for: 192 hours at 40 °C + 5 °C + 0° C and < 5 % RH (dry air/introgen) or 96 hours at 60 °C + 5° C and < 5 % RH for all device containers or 24 hours at 125 °C ± 5 °C not suitable for reels or tubes Bag Seal Date: (If blank, see barcode label) Note: Level and body temperature defined by EIA JEDEC Standard J-STD-020

EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

## **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.



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